

Absolute Maximum Ratings — Standard Triacs

Symbol	Parameter			Value	Unit
$I_{T(RMS)}$	RMS on-state current (full sine wave)	Qxx04Ly	$T_C = 105^\circ\text{C}$	4	A
		Qxx04Ry/Qxx04Vy/Qxx04Dy	$T_C = 110^\circ\text{C}$		
I_{TSM}	Non repetitive surge peak on-state current (full cycle, T_J initial = 25°C)	f = 50 Hz	t = 20 ms	46	A
		f = 60 Hz	t = 16.7 ms	55	
I^2t	I^2t Value for fusing	$t_p = 8.3$ ms		12.5	A ² s
di/dt	Critical rate of rise of on-state current ($I_G = 50\text{mA}$ with $\leq 0.1\mu\text{s}$ rise time)	f = 120 Hz	$T_J = 125^\circ\text{C}$	50	A/ μs
I_{GTM}	Peak gate trigger current	$t_p = 20\mu\text{s}$	$T_J = 125^\circ\text{C}$	4	A
$P_{G(AV)}$	Average gate power dissipation		$T_J = 125^\circ\text{C}$	0.3	W
T_{stg}	Storage temperature range			-40 to 150	$^\circ\text{C}$
T_J	Operating junction temperature range			-40 to 125	$^\circ\text{C}$

Note: xx = voltage/10, y = sensitivity

Electrical Characteristics ($T_J = 25^\circ\text{C}$, unless otherwise specified) — Sensitive Triac (4 Quadrants)

Symbol	Test Conditions	Quadrant		Lxx04x3	Lxx04x5	Lxx04x6	Lxx04x8	Unit
I_{GT}	$V_D = 12\text{V}$ $R_L = 60\ \Omega$	I – II – III	MAX.	3	5	5	10	mA
		IV		3	5	10	20	
V_{GT}	$V_D = 12\text{V}$ $R_L = 60\ \Omega$	ALL	MAX.	1.3				V
V_{GD}	$V_D = V_{DRM}$ $R_L = 3.3\ \text{k}\Omega$ $T_J = 110^\circ\text{C}$	ALL	MIN.	0.2				V
I_H	$I_T = 100\text{mA}$		MAX.	5	10	10	15	mA
dv/dt	$V_D = V_{DRM}$ Gate Open $T_J = 100^\circ\text{C}$	400V	TYP.	25	25	30	35	V/ μs
		600V		15	15	20	25	
(dv/dt)c	(di/dt)c = 2.16 A/ms $T_J = 110^\circ\text{C}$		TYP.	0.5	1	1	1	V/ μs
t_{gt}	$I_G = 2 \times I_{GT}$ PW = 15 μs $I_T = 5.6\ \text{A(pk)}$		TYP.	2.8	3.0	3.0	3.2	μs

Electrical Characteristics ($T_J = 25^\circ\text{C}$, unless otherwise specified) — Standard Triac

Symbol	Test Conditions	Quadrant		Qxx04x3	Qxx04x4	Unit
I_{GT}	$V_D = 12\text{V}$ $R_L = 60\ \Omega$	I – II – III	MAX.	10	25	mA
		IV	TYP.	25	50	
V_{GT}	$V_D = 12\text{V}$ $R_L = 60\ \Omega$	I – II – III	MAX.	1.3	1.3	V
V_{GD}	$V_D = V_{DRM}$ $R_L = 3.3\ \text{k}\Omega$ $T_J = 125^\circ\text{C}$	ALL	MIN.	0.2	0.2	V
I_H	$I_T = 200\text{mA}$		MAX.	20	30	mA
dv/dt	$V_D = V_{DRM}$ Gate Open $T_J = 125^\circ\text{C}$	400V	MIN.	40	75	V/ μs
		600V		30	50	
		800V			40	
	$V_D = V_{DRM}$ Gate Open $T_J = 100^\circ\text{C}$	1000V			50	
(dv/dt)c	(di/dt)c = 2.16 A/ms $T_J = 125^\circ\text{C}$		TYP.	2	2	V/ μs
t_{gt}	$I_G = 2 \times I_{GT}$ PW = 15 μs $I_T = 5.6\ \text{A(pk)}$		TYP.	2.5	3.0	μs
dv/dt	$V_D = 2/3\ V_{DRM}$ Gate Open $T_J = 125^\circ\text{C}$	800V		40		V/ μs

Note: xx = voltage/10, x = package

Static Characteristics ($T_J = 25^\circ\text{C}$, unless otherwise specified)

Symbol	Test Conditions				Value	Unit
V_{TM}	$I_{TM} = 5.6\text{A}$ $t_p = 380\text{ }\mu\text{s}$	MAX.				1.60 V
I_{DRM} I_{RRM}	$V_{DRM} = V_{RRM}$	MAX.	Lxx04xy	$T_J = 25^\circ\text{C}$	400-600V	5 μA
				$T_J = 110^\circ\text{C}$	400-600V	200 μA
			Qxx04xy	$T_J = 25^\circ\text{C}$	400-1000V	10 μA
				$T_J = 125^\circ\text{C}$	400-800V	2 μA
				$T_J = 100^\circ\text{C}$	1000V	3 mA

Thermal Resistances

Symbol	Parameter		Value	Unit
$R_{\theta(J-C)}$	Junction to case (AC)	L/Qxx04Dy	1.5	$^\circ\text{C/W}$
		L/Qxx04Ly	3.5	
		L/Qxx04Ry	2.2	
		L/Qxx04Vy	1.5	
$R_{\theta(J-A)}$	Junction to ambient	L/Qxx04Ly	50	$^\circ\text{C/W}$
		L/Qxx04Ry	45	
		L/Qxx04Vy	70	

Note: xx = voltage/10, x = package, y = sensitivity

Figure 1: Definition of Quadrants

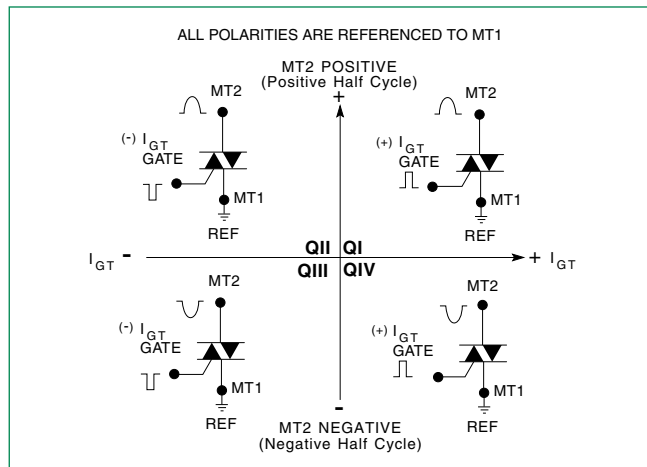
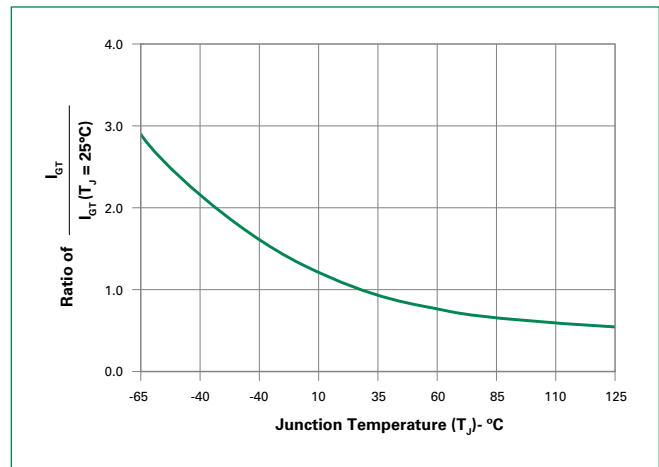


Figure 2: Normalized DC Gate Trigger Current for All Quadrants vs. Junction Temperature



Additional Information



Datasheet



Resources



Samples

Figure 3: Normalized DC Holding Current vs. Junction Temperature

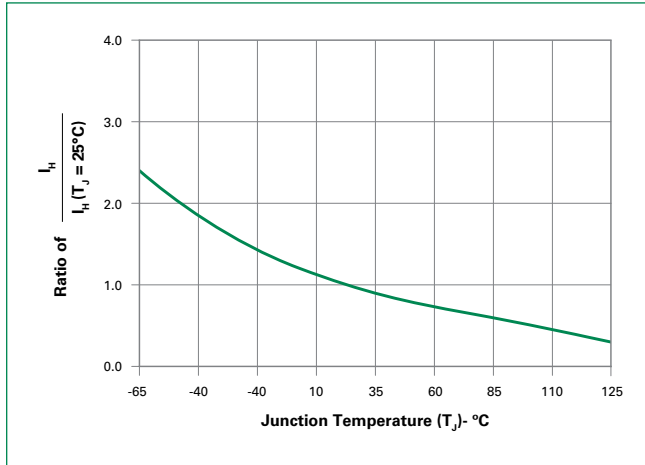


Figure 4: Normalized DC Gate Trigger Voltage for All Quadrants vs. Junction Temperature

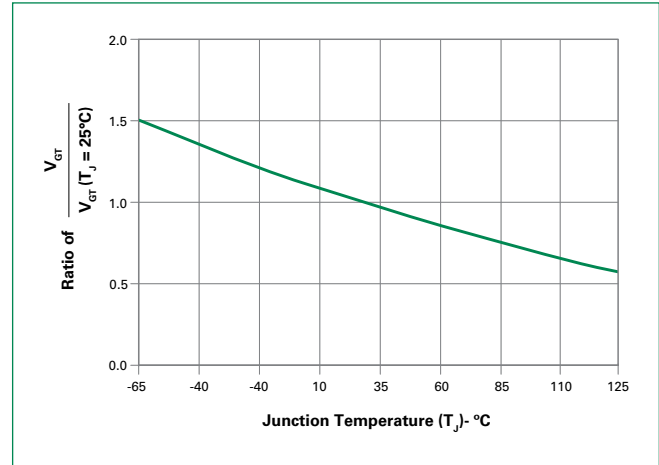


Figure 5: Power Dissipation (Typical) vs. RMS On-State Current

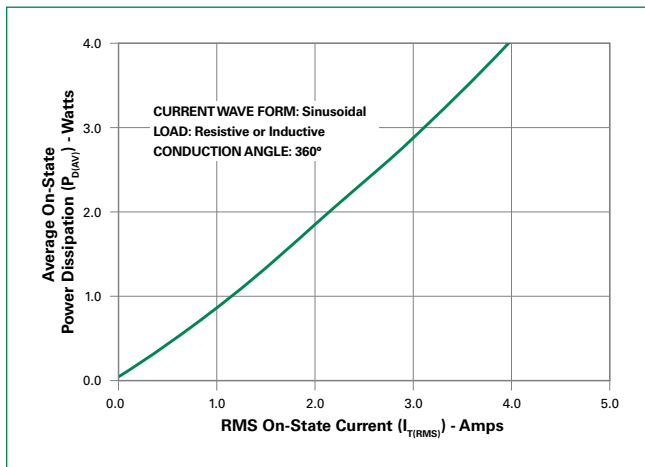


Figure 6: Maximum Allowable Case Temperature vs. On-State Current

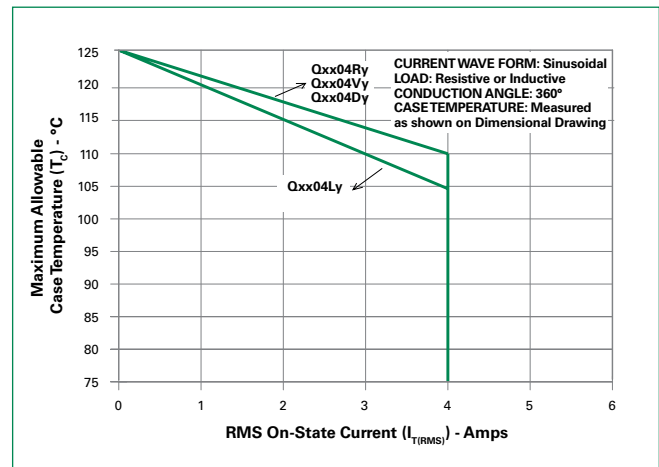


Figure 7: Maximum Allowable Case Temperature vs. On-State Current

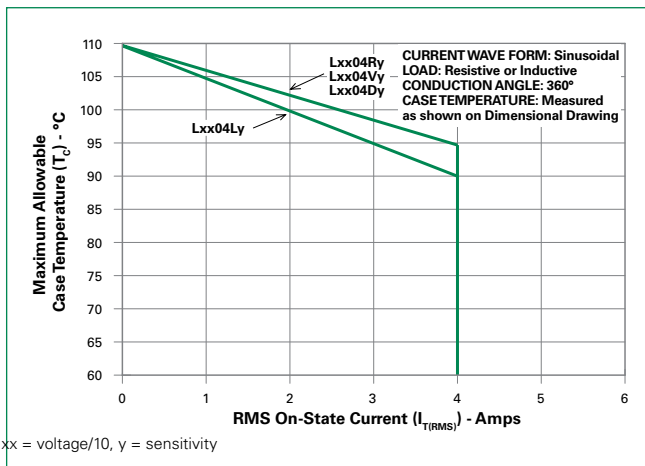
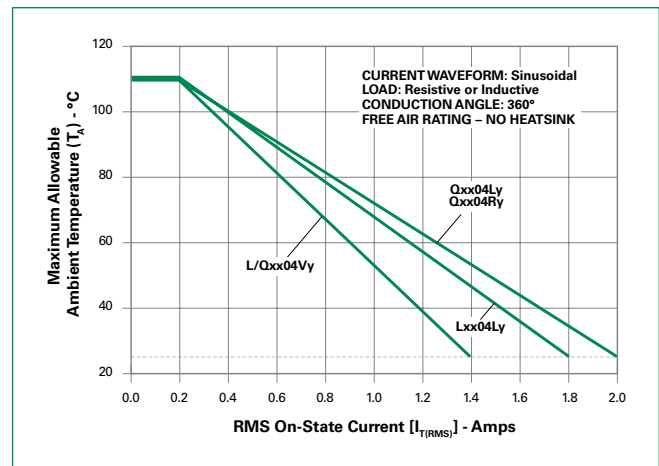


Figure 8: Maximum Allowable Ambient Temperature vs. On-State Current



Note: xx = voltage/10, y = sensitivity

Figure 9: On-State Current vs. On-State Voltage (Typical)

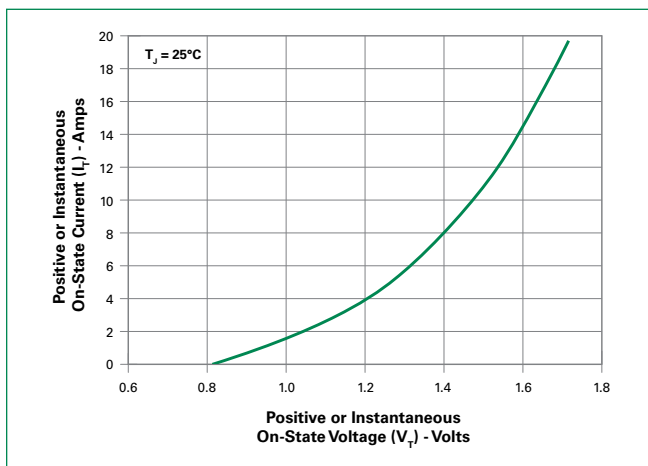
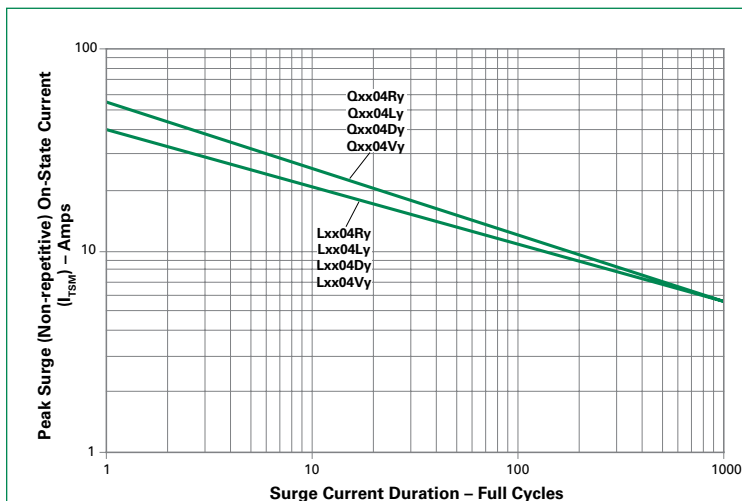


Figure 10: Surge Peak On-State Current vs. Number of Cycles



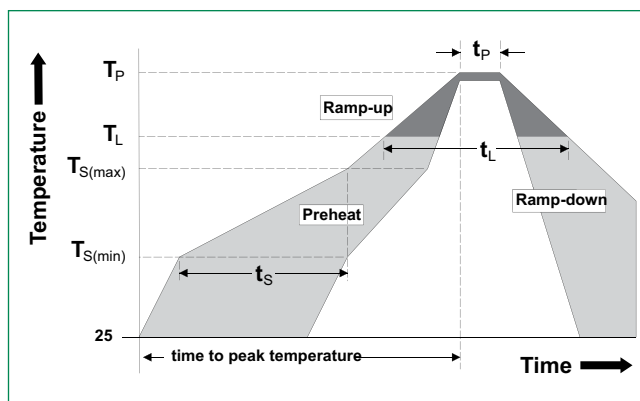
Supply Frequency: 60Hz Sinusoidal
Load: Resistive
RMS On-State ($I_{T(RMS)}$): Max Rated Value at Specific Case Temperature

- Notes:
- Gate control may be lost during and immediately following surge current interval.
 - Overload may not be repeated until junction temperature has returned to steady-state rated value.

Note: xx = voltage/10, y = sensitivity

Soldering Parameters

Reflow Condition		Pb – Free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp) (T_L) to peak		5°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		5°C/second max
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Temperature (t_L)	60 – 150 seconds
Peak Temperature (T_p)		260°C $+0/-5$
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		5°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes Max.
Do not exceed		280°C



Physical Specifications

Terminal Finish	100% Matte Tin-plated
Body Material	UL Recognized compound meeting flammability rating V-0
Terminal Material	Copper Alloy

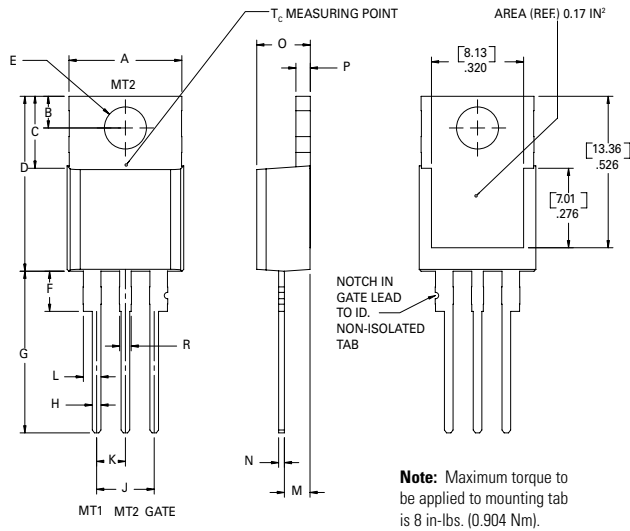
Design Considerations

Careful selection of the correct component for the application's operating parameters and environment will go a long way toward extending the operating life of the Thyristor. Good design practice should limit the maximum continuous current through the main terminals to 75% of the component rating. Other ways to ensure long life for a power discrete semiconductor are proper heat sinking and selection of voltage ratings for worst case conditions. Overheating, overvoltage (including dv/dt), and surge currents are the main killers of semiconductors. Correct mounting, soldering, and forming of the leads also help protect against component damage.

Environmental Specifications

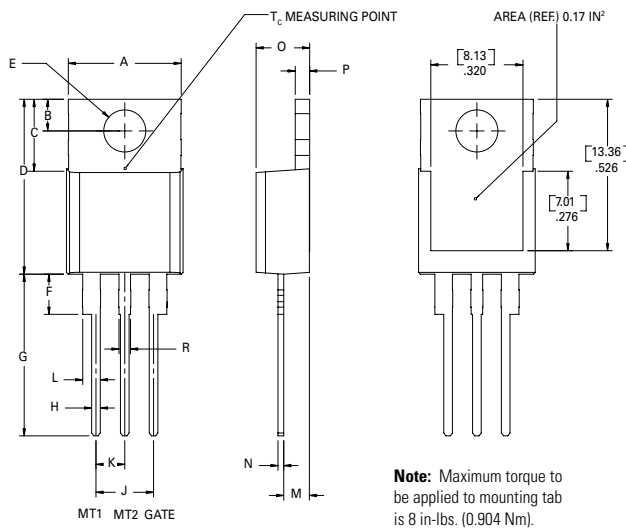
Test	Specifications and Conditions
AC Blocking	MIL-STD-750, M-1040, Cond A Applied Peak AC voltage @ 125°C for 1008 hours
Temperature Cycling	MIL-STD-750, M-1051, 100 cycles; -40°C to +150°C; 15-min dwell time
Temperature/Humidity	EIA / JEDEC, JESD22-A101 1008 hours; 320V - DC: 85°C; 85% rel humidity
High Temp Storage	MIL-STD-750, M-1031, 1008 hours; 150°C
Low-Temp Storage	1008 hours; -40°C
Resistance to Solder Heat	MIL-STD-750 Method 2031
Solderability	ANSI/J-STD-002, category 3, Test A
Lead Bend	MIL-STD-750, M-2036 Cond E

Dimensions — TO-220AB (R-Package) — Non-Isolated Mounting Tab Common with Center Lead



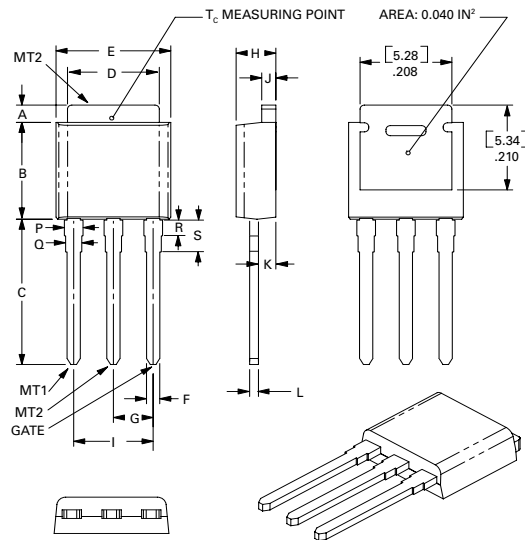
Dimension	Inches		Millimeters	
	Min	Max	Min	Max
A	0.380	0.420	9.65	10.67
B	0.105	0.115	2.67	2.92
C	0.230	0.250	5.84	6.35
D	0.590	0.620	14.99	15.75
E	0.142	0.147	3.61	3.73
F	0.110	0.130	2.79	3.30
G	0.540	0.575	13.72	14.61
H	0.025	0.035	0.64	0.89
J	0.195	0.205	4.95	5.21
K	0.095	0.105	2.41	2.67
L	0.060	0.075	1.52	1.91
M	0.085	0.095	2.16	2.41
N	0.018	0.024	0.46	0.61
O	0.178	0.188	4.52	4.78
P	0.045	0.060	1.14	1.52
R	0.038	0.048	0.97	1.22

Dimensions — TO-220AB (L-Package) — Isolated Mounting Tab



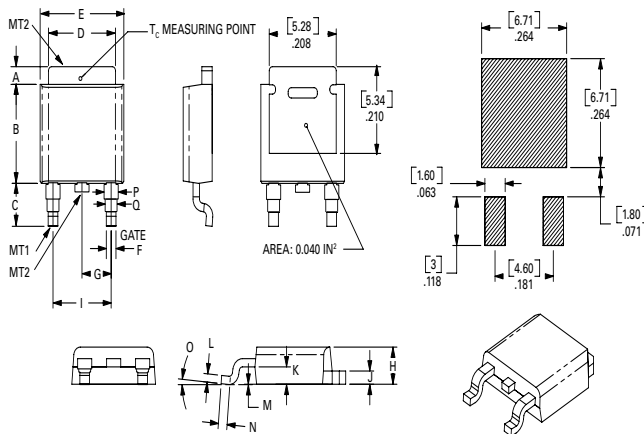
Dimension	Inches		Millimeters	
	Min	Max	Min	Max
A	0.380	0.420	9.65	10.67
B	0.105	0.115	2.67	2.92
C	0.230	0.250	5.84	6.35
D	0.590	0.620	14.99	15.75
E	0.142	0.147	3.61	3.73
F	0.110	0.130	2.79	3.30
G	0.540	0.575	13.72	14.61
H	0.025	0.035	0.64	0.89
J	0.195	0.205	4.95	5.21
K	0.095	0.105	2.41	2.67
L	0.060	0.075	1.52	1.91
M	0.085	0.095	2.16	2.41
N	0.018	0.024	0.46	0.61
O	0.178	0.188	4.52	4.78
P	0.045	0.060	1.14	1.52
R	0.038	0.048	0.97	1.22

Dimensions — TO-251AA (V-Package) — V-PAK Through Hole



Dim	Inches			Millimeters		
	Min	Typ	Max	Min	Typ	Max
A	0.037	0.040	0.043	0.94	1.01	1.09
B	0.235	0.242	0.245	5.97	6.15	6.22
C	0.350	0.361	0.375	8.89	9.18	9.53
D	0.205	0.208	0.213	5.21	5.29	5.41
E	0.255	0.262	0.265	6.48	6.66	6.73
F	0.027	0.031	0.033	0.69	0.80	0.84
G	0.087	0.090	0.093	2.21	2.28	2.36
H	0.085	0.092	0.095	2.16	2.34	2.41
I	0.176	0.180	0.184	4.47	4.57	4.67
J	0.018	0.020	0.023	0.46	0.51	0.58
K	0.035	0.037	0.039	0.90	0.95	1.00
L	0.018	0.020	0.023	0.46	0.52	0.58
P	0.042	0.047	0.052	1.06	1.20	1.32
Q	0.034	0.039	0.044	0.86	1.00	1.11
R	0.034	0.039	0.044	0.86	1.00	1.11
S	0.074	0.079	0.084	1.86	2.00	2.11

Dimensions — TO-252AA (D-Package) — D-PAK Surface Mount



Dim	Inches			Millimeters		
	Min	Typ	Max	Min	Typ	Max
A	0.037	0.040	0.043	0.94	1.01	1.09
B	0.235	0.243	0.245	5.97	6.16	6.22
C	0.106	0.108	0.113	2.69	2.74	2.87
D	0.205	0.208	0.213	5.21	5.29	5.41
E	0.255	0.262	0.265	6.48	6.65	6.73
F	0.027	0.031	0.033	0.69	0.80	0.84
G	0.087	0.090	0.093	2.21	2.28	2.36
H	0.085	0.092	0.095	2.16	2.33	2.41
I	0.176	0.179	0.184	4.47	4.55	4.67
J	0.018	0.020	0.023	0.46	0.51	0.58
K	0.035	0.037	0.039	0.90	0.95	1.00
L	0.018	0.020	0.023	0.46	0.51	0.58
M	0.000	0.000	0.004	0.00	0.00	0.10
N	0.021	0.026	0.027	0.53	0.67	0.69
O	0°	0°	5°	0°	0°	5°
P	0.042	0.047	0.052	1.06	1.20	1.32
Q	0.034	0.039	0.044	0.86	1.00	1.11

Thyristors

4 Amp Sensitive & Standard Triacs

Product Selector

Part Number	Voltage				Gate Sensitivity Quadrants		Type	Package
	400V	600V	800V	1000V	I – II – III	IV		
Lxx04L3	X	X	-	-	3 mA	3 mA	Sensitive Triac	TO-220L
Lxx04D3	X	X	-	-	3 mA	3 mA	Sensitive Triac	TO-252 D-PAK
Lxx04R3	X	X	-	-	3mA	3mA	Sensitive Triac	TO-220R
Lxx04V3	X	X	-	-	3 mA	3 mA	Sensitive Triac	TO-251 V-PAK
Lxx04L5	X	X	-	-	5 mA	5 mA	Sensitive Triac	TO-220L
Lxx04D5	X	X	-	-	5 mA	5 mA	Sensitive Triac	TO-252 D-PAK
Lxx04R5	X	X	-	-	5mA	5mA	Sensitive Triac	TO-220R
Lxx04V5	X	X	-	-	5 mA	5 mA	Sensitive Triac	TO-251 V-PAK
Lxx04L6	X	X	-	-	5 mA	10 mA	Sensitive Triac	TO-220L
Lxx04D6	X	X	-	-	5 mA	10 mA	Sensitive Triac	TO-252 D-PAK
Lxx04R6	X	X	-	-	5mA	10mA	Sensitive Triac	TO-220R
Lxx04V6	X	X	-	-	5 mA	10 mA	Sensitive Triac	TO-251 V-PAK
Lxx04L8	X	X	-	-	10 mA	20 mA	Sensitive Triac	TO-220L
Lxx04D8	X	X	-	-	10 mA	20 mA	Sensitive Triac	TO-252 D-PAK
Lxx04R8	X	X	-	-	10mA	20mA	Sensitive Triac	TO-220R
Lxx04V8	X	X	-	-	10 mA	20 mA	Sensitive Triac	TO-251 V-PAK
Qxx04L3	X	X	X	-	10 mA	-	Standard Triac	TO-220L
Qxx04D3	X	X	X	-	10 mA	-	Standard Triac	TO-252 D-PAK
Qxx04V3	X	X	X	-	10 mA	-	Standard Triac	TO-251 V-PAK
Qxx04R3	X	X	X	-	10mA	-	Standard Triac	TO-220R
Qxx04L4	X	X	X	X	25 mA	-	Standard Triac	TO-220L
Qxx04D4	X	X	X	X	25 mA	-	Standard Triac	TO-252 D-PAK
Qxx04R4	X	X	X	X	25mA	-	Standard Triac	TO-220R
Qxx04V4	X	X	X	X	25 mA	-	Standard Triac	TO-251 V-PAK

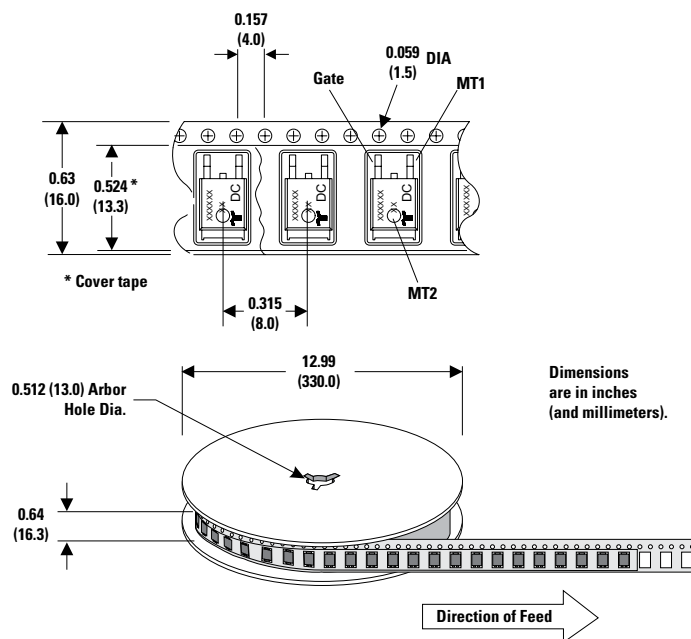
Packing Options

Part Number	Marking	Weight	Packing Mode	Base Quantity
L/Qxx04LyTP	L/Qxx04Ly	2.2 g	Tube	1000 (50 per tube)
L/Qxx04DyRP	L/Qxx04Dy	0.3 g	Embossed Carrier	2500
L/Qxx04DyTP	L/Qxx04Dy	0.3 g	Tube Pack	750 (75 per tube)
L/Qxx04VyTP	L/Qxx04Vy	0.4 g	Tube Pack	750 (75 per tube)
L/Qxx04LyTP	L/Qxx04Ly	2.2g	Tube	1000 (50 per tube)
L/Qxx04RyTP	L/Qxx04Ry	2.2g	Tube	1000 (50 per tube)

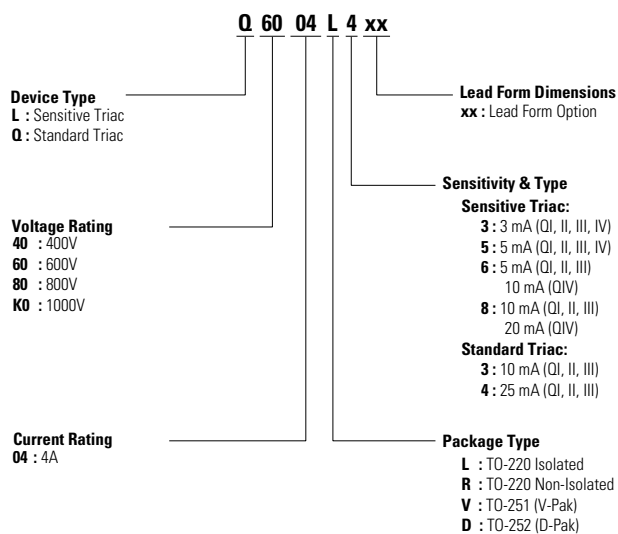
Note: xx = Voltage/10; y = Sensitivity

TO-252 Embossed Carrier Reel Pack (RP) Specifications

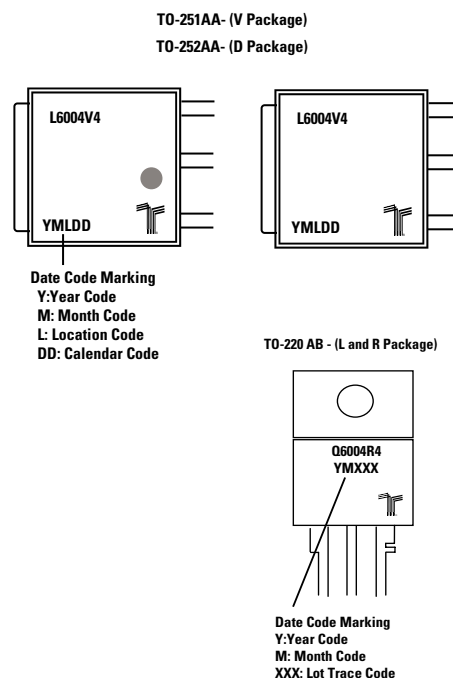
Meets all EIA-481-2 Standards



Part Numbering System



Part Marking System



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